



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Connell et al.

**Serial No.:** 10/706,212

**Filed:** November 12, 2003

**For:** WAFER BACK SIDE COATING TO  
BALANCE STRESS FROM PASSIVATION  
LAYER ON FRONT OF WAFER AND BE  
USED AS A DIE ATTACH ADHESIVE

**Confirmation No.:** 6326

**Examiner:** A. Wilson

**Group Art Unit:** 2815

**Attorney Docket No.:** 2269-5083.1US  
01-0428.01/US

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 9, 2006  
Date

*Leta M. Howard*  
Signature

Leta M. Howard  
Name (Type/Print)

**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed October 7, 2005, the three-month shortened statutory period for response to which expires on January 9, 2005, January 7<sup>th</sup> being a Saturday.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 7 of this paper.